

Low Dropout Linear Voltage Regulator

# TLS850F0TAV33

TLS850F0TAV33

# Linear Voltage Regulator

# Data Sheet

Rev. 1.0, 2015-12-01

Automotive Power



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## Low Dropout Linear Voltage Regulator

### TLS850F0TAV33



#### Features

- Wide Input Voltage Range from 3.0 V to 40 V
- Fixed Output Voltage 3.3 V
- Output Voltage Precision ≤ ±2 %
- Output Current Capability up to 500 mA
- Ultra Low Current Consumption typ. 40 μA
- Very Low Dropout Voltage typ. 80 mV@100 mA
- Stable with Ceramic Output Capacitor of 1 µF
- Delayed Reset at Power-On: 16.5 ms
- Adjustable Reset Threshold down to 2.50 V
- Watchdog with fixed timing and current dependent deactivation: 96 ms, Activated at  $I_{\rm Q}$  > 5.5 mA
- Enable, Undervoltage Reset, Overtemperature Shutdown
- Output Current Limitation
- Wide Temperature Range
- Green Product (RoHS compliant)
- AEC Qualified



Figure 1 PG-TO263-7



**Overview** 

#### **Functional Description**

The TLS850F0TAV33 is a high performance very low dropout linear voltage regulator for 3.3 V supply in a PG-TO263-7 package.

With an input voltage range of 3 V to 40 V and very low quiescent of only 40  $\mu$ A, these regulators are perfectly suitable for automotive or any other supply systems connected to the battery permanently. The TLS850F0TAV33 provides an output voltage accuracy of 2 % and a maximum output current up to 500 mA.

The new loop concept combines fast regulation and very good stability while requiring only one small ceramic capacitor of 1  $\mu$ F at the output. At currents below 100 mA the device will have a very low typical dropout voltage of only 80 mV. The operating range starts already at input voltages of only 3 V (extended operating range). This makes the TLS850F0TAV33 also suitable to supply automotive systems that need to operate during cranking condition.

The device can be switched on and off by the Enable feature as described in **Chapter 5.5**.

The output voltage is supervised by the Reset feature, including Undervoltage Reset, delayed Reset at Power-On and an adjustable lower Reset Threshold, more details can be found in **Chapter 5.7**.

In addition, a Watchdog circuit with fixed timing is integrated to monitor the microcontroller's operation.

Internal protection features like output current limitation and overtemperature shutdown are implemented to protect the device against immediate damage due to failures like output short circuit to GND, over-current and over-temperatures.

#### **Choosing External Components**

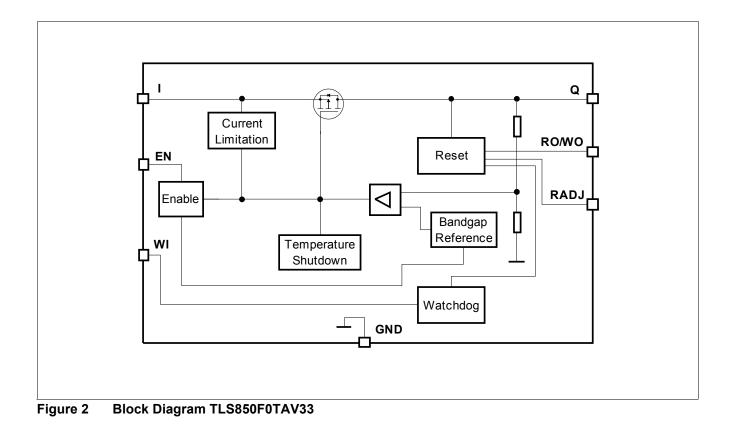
An input capacitor  $C_1$  is recommended to compensate line influences. The output capacitor  $C_Q$  is necessary for the stability of the regulating circuit. TLS850F0TAV33 is designed to be also stable with low ESR ceramic capacitors.

Туре	Package	Marking
TLS850F0TAV33	PG-TO263-7	850F0V33



**Block Diagram** 

## 2 Block Diagram

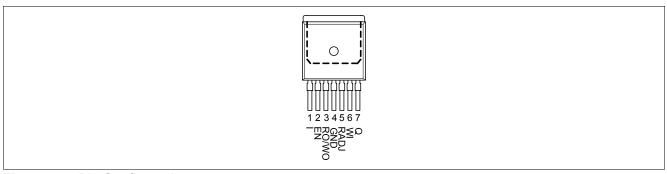




#### **Pin Configuration**

## 3 Pin Configuration

## 3.1 Pin Assignment TLS850F0TAV33



## Figure 3 Pin Configuration

## 3.2 Pin Definitions and Functions TLS850F0TAV33

Pin	Symbol	Function
1	I	Input It is recommended to place a small ceramic capacitor (e.g. 100 nF) to GND, close to the IC terminals, in order to compensate line influences. See also Chapter 6.2.1
2	EN	<b>Enable</b> (integrated pull-down resistor) Enable the IC with high level input signal; Disable the IC with low level input signal;
3	RO/WO	Reset Output / Watchdog Output (intergrated pull-up resistor to Q)Open collector output;Leave open if the reset and watchdog function are not needed
4	GND	Ground
5	RADJ	Reset Threshold Adjustment Connect to GND to use standard value; Connect an external voltage divider to adjust reset threshold
6	WI	Watchdog Input (integrated pull-down resistor) Serve Watchdog with trigger input signal (usable for microcontroller monitoring)
7	Q	Output Voltage Connect output capacitor $C_Q$ to GND close to the IC's terminals, respecting the values specified for its capacitance and ESR in "Functional Range" on Page 8
Heat Slug	_	Heat Slug Connect to heatsink area; Connect to GND



**General Product Characteristics** 

## 4 General Product Characteristics

## 4.1 Absolute Maximum Ratings

### Table 1 Absolute Maximum Ratings<sup>1)</sup>

 $T_i$  = -40 °C to +150 °C; all voltages with respect to ground (unless otherwise specified)

Symbol		Value	S	Unit	Note /	Number	
	Min.	Тур.	Max.		<b>Test Condition</b>		
1	1		1	1		4	
$V_{\rm I}, V_{\rm EN}$	-0.3	-	45	V	-	P_4.1.1	
/WO				- #			
V <sub>Q</sub> , V <sub>RO/WO</sub>	-0.3	-	7	V	-	P_4.1.3	
Adjustment	RADJ	-				<u>+</u>	
$V_{\rm WI}$ , $V_{\rm RADJ}$	-0.3	-	7	V	-	P_4.1.5	
<u>+</u>	*	-				<u>+</u>	
Tj	-40	-	150	°C	-	P_4.1.7	
T <sub>stg</sub>	-55	-	150	°C	-	P_4.1.8	
$V_{ESD}$	-2	-	2	kV	<sup>2)</sup> HBM	P_4.1.9	
$V_{ESD}$	-500	-	500	V	<sup>3)</sup> CDM	P_4.1.10	
V <sub>ESD1,7</sub>	-750	-	750	V	<sup>3)</sup> CDM	P_4.1.12	
	$V_{I}, V_{EN}$ $V_{Q}, V_{RO/WO}$ Adjustment I $V_{WI}, V_{RADJ}$ $T_{j}$ $T_{stg}$ $V_{ESD}$ $V_{ESD}$	Min. $V_{I}, V_{EN}$ -0.3 $V$ WO         -0.3 $V_{Q}, V_{RO/WO}$ -0.3           Adjustment RADJ         -0.3 $V_{WI}, V_{RADJ}$ -0.3 $T_j$ -40 $T_{stg}$ -55 $V_{ESD}$ -2 $V_{ESD}$ -500	Min.         Typ. $V_{1}, V_{EN}$ -0.3         - $VWO$ -0.3         - $V_{Q}, V_{RO/WO}$ -0.3         -           Adjustment RADJ         -         - $V_{WI}, V_{RADJ}$ -0.3         - $T_{j}$ -40         - $T_{stg}$ -55         - $V_{ESD}$ -2         - $V_{ESD}$ -500         -	Min.         Typ.         Max. $V_{\rm I}, V_{\rm EN}$ -0.3         -         45           /WO         //WO         -         7           Adjustment RADJ         -         7 $V_{\rm WI}, V_{\rm RADJ}$ -0.3         -         7           Tj         -40         -         150 $T_{\rm stg}$ -55         -         150 $V_{\rm ESD}$ -2         -         2 $V_{\rm ESD}$ -500         -         500	Min.         Typ.         Max. $V_{\rm I}, V_{\rm EN}$ -0.3         -         45         V $V_{\rm Q}, V_{\rm RO/WO}$ -0.3         -         7         V           Adjustment RADJ         -         7         V $V_{\rm WI}, V_{\rm RADJ}$ -0.3         -         7         V $T_{\rm j}$ -40         -         150         °C $T_{\rm stg}$ -55         -         150         °C $V_{\rm ESD}$ -2         -         2         kV $V_{\rm ESD}$ -500         -         500         V	Min.         Typ.         Max.         Test Condition $V_1, V_{EN}$ -0.3         -         45         V         -           VWO         V         -         Adjustment RADJ         V         - $V_{WV}, V_{RADJ}$ -0.3         -         7         V         - $T_j$ -40         -         150         °C         - $T_{stg}$ -55         -         150         °C         - $V_{ESD}$ -2         -         2         kV         2) HBM $V_{ESD}$ -500         -         500         V         3) CDM	

1) Not subject to production test, specified by design.

2) ESD susceptibility, HBM according to ANSI/ESDA/JEDEC JS001 (1.5 k $\Omega$ , 100 pF)

3) ESD susceptibility, Charged Device Model "CDM" according JEDEC JESD22-C101

Note:

- 1. Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- 2. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.



#### **General Product Characteristics**

## 4.2 Functional Range

#### Table 2Functional Range

 $T_i$  = -40 °C to +150 °C; all voltages with respect to ground (unless otherwise specified)

Parameter	Symbol	v	alues		Unit	Note / Test Condition	Number
		Min.	Тур.	Max.			
Input Voltage Range	$V_{\rm I}$	$V_{\rm Q,nom}$ + $V_{\rm dr}$	-	40	V	1) _	P_4.2.1
Extended Input Voltage Range	V <sub>I,ext</sub>	3.0	-	40	V	<sup>2)</sup> _	P_4.2.3
Enable Voltage Range	$V_{\sf EN}$	0	-	40	V	-	P_4.2.5
Output Capacitor's Requirements for Stability	CQ	1	-	-	μF	3)4)	P_4.2.6
ESR	$ESR(C_Q)$	_	-	100	Ω	<sup>3)</sup> _	P_4.2.7
Junction Temperature	Tj	-40	-	150	°C	-	P_4.2.9

1) Output current is limited internaly and depends on the input voltage, see Electrical Characteristics for more details.

2) When  $V_{\rm l}$  is between  $V_{\rm l,ext,min}$  and  $V_{\rm Q,nom} + V_{\rm dr}$ ,  $V_{\rm Q} = V_{\rm l} - V_{\rm dr}$ . When  $V_{\rm l}$  is below  $V_{\rm l,ext,min}$ ,  $V_{\rm Q}$  can drop down to 0 V.

3) Not subject to production test, specified by design.

4) The minimum output capacitance requirement is applicable for a worst case capacitance tolerance of 30%

Note: Within the functional or operating range, the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the Electrical Characteristics table.



#### **General Product Characteristics**

### 4.3 Thermal Resistance

#### Table 3Thermal Resistance

Parameter	Symbol	Values			Unit	Note /	Number
		Min.	Тур.	Max.		<b>Test Condition</b>	
Package Version PG-TO26	63-7	-1			<b>I</b>	-	-
Junction to Case	$R_{thJC}$	-	3	-	K/W	1)	P_4.3.6
Junction to Ambient	R <sub>thJA</sub>	-	21	-	K/W	<sup>1)2)</sup> 2s2p board	P_4.3.7
Junction to Ambient	R <sub>thJA</sub>	-	75	-	K/W	<sup>1)3)</sup> 1s0p board, footprint only	P_4.3.8
Junction to Ambient	R <sub>thJA</sub>	-	42	-	K/W	<sup>1)3)</sup> 1s0p board, 300 mm <sup>2</sup> heatsink area on PCB	P_4.3.9
Junction to Ambient	R <sub>thJA</sub>	-	34	-	K/W	<sup>1)3)</sup> 1s0p board, 600 mm <sup>2</sup> heatsink area on PCB	P_4.3.10

1) Not subject to production test, specified by design

 Specified R<sub>thJA</sub> value is according to Jedec JESD51-2,-5,-7 at natural convection on FR4 2s2p board; The Product (Chip+Package) was simulated on a 76.2 x 114.3 x 1.5 mm<sup>3</sup> board with 2 inner copper layers (2 x 70µm Cu, 2 x 35µm Cu). Where applicable a thermal via array under the exposed pad contacted the first inner copper layer.

3) Specified  $R_{\text{thJA}}$  value is according to JEDEC JESD 51-3 at natural convection on FR4 1s0p board; The Product (Chip+Package) was simulated on a 76.2 × 114.3 × 1.5 mm<sup>3</sup> board with 1 copper layer (1 x 70µm Cu).

Note: This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, go to www.jedec.org.



## 5 Block Description and Electrical Characteristics

## 5.1 Voltage Regulation

The output voltage  $V_{\rm Q}$  is divided by a resistor network. This fractional voltage is compared to an internal voltage reference and the pass transistor is driven accordingly.

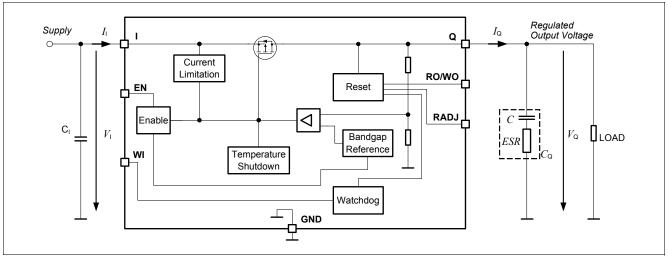
The control loop stability depends on the output capacitor  $C_Q$ , the load current, the chip temperature and the internal circuit design. To ensure stable operation, the output capacitor's capacitance and its equivalent series resistor (ESR) requirements given in "Functional Range" on Page 8 have to be maintained. For details, also see the typical performance graph "Output Capacitor Series Resistor ESR(CQ) versus Output Current IQ" on Page 13. As the output capacitor also has to buffer load steps, it should be sized according to the application's needs.

An input capacitor  $C_1$  is recommended to compensate line influences. In order to block influences like pulses and HF distortion at input side, an additional reverse polarity protection diode and a combination of several capacitors for filtering should be used. Connect the capacitors close to the component's terminals.

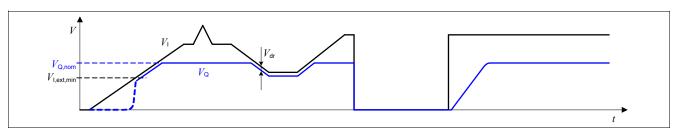
In order to prevent overshoots during start-up, a smooth ramp up function is implemented. This ensures almost no output voltage overshoots during start-up, mostly independent from load and output capacitance.

Whenever the load current exceeds the specified limit, e.g. in case of a short circuit, the output current is limited and the output voltage decreases.

The overtemperature shutdown circuit prevents the IC from immediate destruction under fault conditions (e.g. output continuously short-circuit) by switching off the power stage. After the chip has cooled down, the regulator restarts. This leads to an oscillatory behavior of the output voltage until the fault is removed. However, junction temperatures above 150 °C are outside the maximum ratings and therefore significantly reduce the IC's lifetime.









Data Sheet



### Table 4 Electrical Characteristics Voltage Regulator 3.3 V version

 $T_j$  = -40 °C to +150 °C,  $V_1$  = 13.5 V, all voltages with respect to ground (unless otherwise specified) Typical values are given at  $T_j$  = 25 °C

Parameter	Symbol	Values			Unit	Note / Test Condition	Number
		Min.	Тур.	Max.	1		
Output Voltage Precision	V <sub>Q</sub>	3.23	3.3	3.37	V	0.05 mA < $I_{\rm Q}$ < 500 mA 4.23 V < $V_{\rm I}$ < 28 V	P_5.1.23
Output Voltage Precision	V <sub>Q</sub>	3.23	3.3	3.37	V	0.05 mA < $I_{\rm Q}$ < 200 mA 3.72 V < $V_{\rm I}$ < 40 V	P_5.1.24
Output Voltage Start-up slew rate	$dV_Q/dt$	3.0	7.5	18	V/ms	$V_1 > 18 V/ms$ $C_Q = 1 \mu F$ 0.33 V < $V_Q$ < 2.97 V	P_5.1.27
Output Current Limitation	$I_{\rm Q,max}$	501	650	1100	mA	0 V < V <sub>Q</sub> < 3.1 V	P_5.1.29
Load Regulation steady-state	$\Delta V_{\rm Q,load}$	-20	-1.5	5	mV	$I_{\rm Q}$ = 0.05 mA to 500 mA $V_{\rm I}$ = 6 V	P_5.1.31
Line Regulation steady-state	$\Delta V_{ m Q,line}$	-15	0	15	mV	$V_1$ = 8 V to 32 V $I_Q$ = 5 mA	P_5.1.33
Dropout Voltage $V_{dr} = V_1 - V_Q$	$V_{\sf dr}$	-	200	430	mV	<sup>1)</sup> $I_{\rm Q}$ = 250 mA	P_5.1.36
Dropout Voltage $V_{dr} = V_1 - V_Q$	$V_{\sf dr}$	-	80	175	mV	<sup>1)</sup> I <sub>Q</sub> = 100 mA	P_5.1.37
Power Supply Ripple Rejection	PSRR	-	63	-	dB	$^{2)}f_{\text{ripple}}$ = 100 Hz $V_{\text{ripple}}$ = 0.5 Vpp	P_5.1.38
Overtemperature Shutdown Threshold	$T_{\rm j,sd}$	151	-	200	°C	<sup>2)</sup> $T_j$ increasing	P_5.1.39
Overtemperature Shutdown Threshold Hysteresis	$T_{\rm j,sdh}$	-	15	-	К	<sup>2)</sup> $T_{\rm j}$ decreasing	P_5.1.40

1) Measured when the output voltage  $V_{\rm Q}$  has dropped 100 mV from the nominal value obtained at  $V_{\rm I}$  = 13.5V

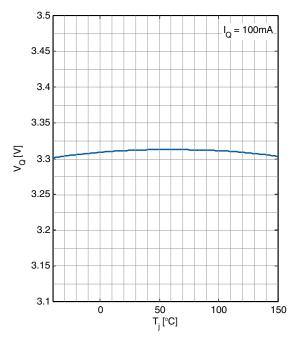
2) Not subject to production test, specified by design



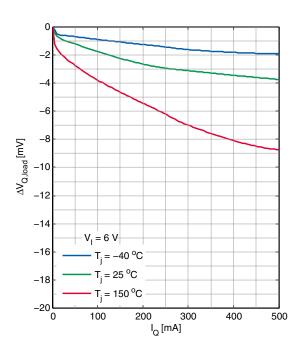
## 5.2 Typical Performance Characteristics Voltage Regulator

#### **Typical Performance Characteristics**

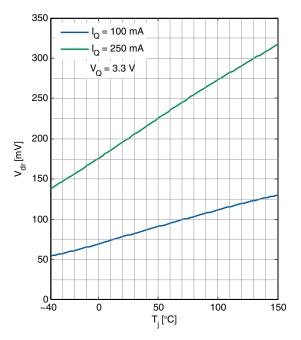
# Output Voltage $V_{Q}$ versus Junction Temperature $T_{j}$



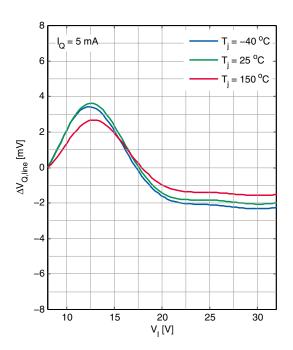
Load Regulation  $\Delta V_{Q,load}$  versus Output Current Change  $I_Q$ 



# Dropout Voltage $V_{dr}$ versus Junction Temperature $T_{j}$

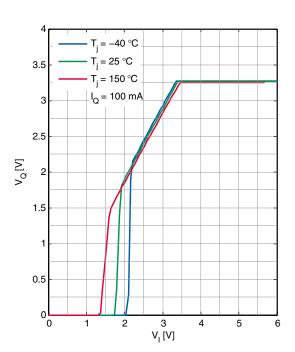


Line Regulation  $\Delta V_{\rm Q,line}$  versus Input Voltage  $V_{\rm I}$ 



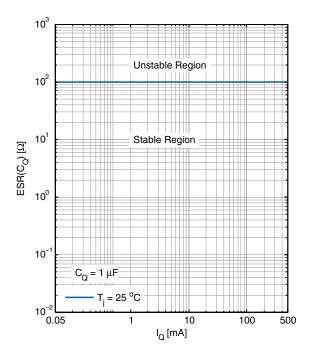
Data Sheet



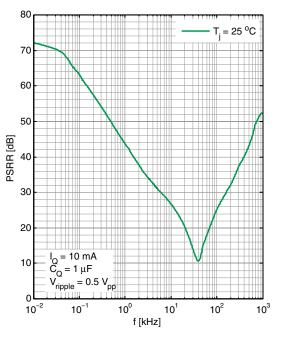


Output Voltage  $V_{\rm Q}$  versus Input Voltage  $V_{\rm I}$ 

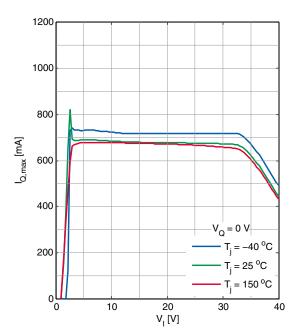
Output Capacitor Series Resistor  $ESR(C_{\rm Q})$  versus Output Current  $I_{\rm Q}$ 



Power Supply Ripple Rejection PSRR versus ripple frequency f



Maximum Output Current  $I_{\rm Q}$  versus Input Voltage  $V_{\rm I}$ 

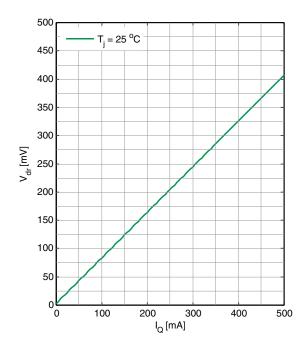




## TLS850F0TAV33

**Block Description and Electrical Characteristics** 

# Dropout Voltage $V_{\rm dr}$ versus Output Current $I_{\rm Q}$





#### 5.3 **Current Consumption**

#### Table 5 **Electrical Characteristics Current Consumption**

 $T_{\rm j}$  = -40 °C to +150 °C,  $V_{\rm l}$  = 13.5 V (unless otherwise specified) Typical values are given at  $T_{\rm j}$  = 25 °C Conditions of other pins: WI = GND

Parameter	Symbol		Values	S	Unit	Note / Test Condition	Number
		Min.	Тур.	Max.			
Current Consumption $I_q = I_1$	I <sub>q,off</sub>	-	1.3	5	μA	$V_{\rm EN}$ = 0 V; $T_{\rm j}$ < 105 °C	P_5.3.1
$\overline{Current Consumption} I_q = I_1$	I <sub>q,off</sub>	-	-	8	μA	$V_{\rm EN}$ = 0.4 V; $T_{\rm j}$ < 125 °C	P_5.3.3
Current Consumption $I_q = I_1 - I_Q$	Iq	_	40	52	μA	$I_{\rm Q}$ = 0.05 mA $T_{\rm j}$ = 25 °C Watchdog disabled	P_5.3.4
Current Consumption $I_q = I_1 - I_Q$	Iq	-	62	77	μA	$I_{\rm Q}$ = 0.05 mA $T_{\rm j}$ < 125 °C Watchdog disabled	P_5.3.7
Current Consumption $I_q = I_1 - I_Q$	Iq	-	62	82	μA	<sup>1)</sup> $I_{\rm Q}$ = 500 mA $T_{\rm j}$ < 125 °C Watchdog enabled	P_5.3.11

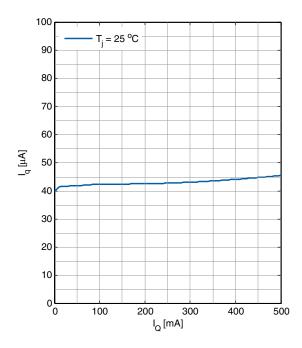
1) Not subject to production test, specified by design



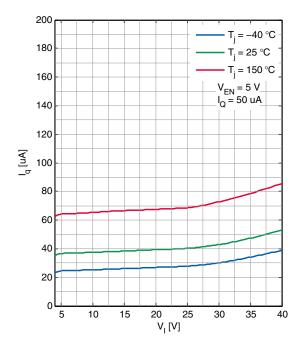
## 5.4 Typical Performance Characteristics Current Consumption

#### **Typical Performance Characteristics**

Current Consumption  $I_{\rm q}$  versus Output Current  $I_{\rm Q}$ 



# Current Consumption $I_q$ versus Input Voltage $V_l$





## 5.5 Enable

The TLS850F0TAV33 can be switched on and off by the Enable feature: Connect a HIGH level as specified below (e.g. the battery voltage) to pin EN to enable the device; connect a LOW level as specified below (e.g. GND) to shut it down. The enable has a built in hysteresis to avoid toggling between ON/OFF state, if signals with slow slopes are applied to the EN input.

### Table 6 Electrical Characteristics Enable

 $T_{\rm j}$  = -40 °C to +150 °C,  $V_{\rm l}$  = 13.5 V, all voltages with respect to ground (unless otherwise specified) Typical values are given at  $T_{\rm j}$  = 25 °C

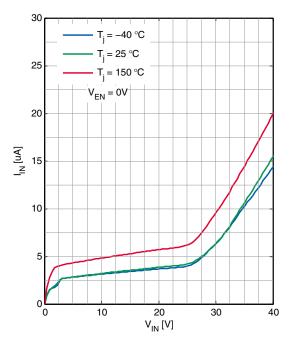
Parameter	Symbol Values			S	Unit	Note / Test Condition	Number
		Min.	Тур.	Max.			
High Level Input Voltage	$V_{\rm EN,H}$	2	-	-	V	$V_{\rm Q}$ settled	P_5.5.1
Low Level Input Voltage	$V_{\rm EN,L}$	-	-	0.8	V	V <sub>Q</sub> ≤ 0.1 V	P_5.5.2
Enable Threshold Hysteresis	$V_{\rm EN,Hy}$	100	-	-	mV	-	P_5.5.3
High Level Input Current	$I_{\rm EN,H}$	-	-	3.5	μA	V <sub>EN</sub> = 3.3 V	P_5.5.4
High Level Input Current	$I_{\rm EN,H}$	-	-	22	μA	V <sub>EN</sub> ≤ 18 V	P_5.5.6
Enable internal pull-down resistor	R <sub>EN</sub>	0.95	1.5	2.6	MΩ	-	P_5.5.7



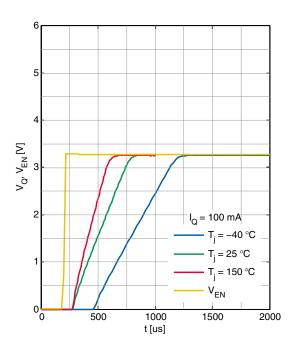
## 5.6 Typical Performance Characteristics Enable

### **Typical Performance Characteristics**

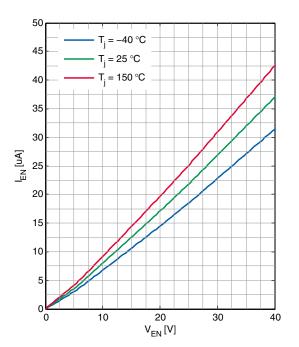
Input Current  $I_{\rm IN}$  versus Input Voltage  $V_{\rm IN}$  (condition:  $V_{\rm EN}$  = 0 V)



Output Voltage  $V_{\rm Q}$  versus time (EN switched ON)



Enabled Input Current  $I_{\rm EN}$  versus Enabled Input Voltage  $V_{\rm EN}$ 



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## 5.7 Reset

The TLS850F0TAV33's output voltage is supervised by the Reset feature, including Undervoltage Reset, delayed Reset at Power-On and an adjustable Reset Threshold.

The Undervoltage Reset function sets the pin RO/WO to LOW, in case  $V_{\rm Q}$  is falling for any reason below the Reset Threshold  $V_{\rm RT,low}$ .

When the regulator is powered on, the pin RO/WO is held at LOW for the duration of the Power-On Reset Delay Time  $t_{rd}$ .

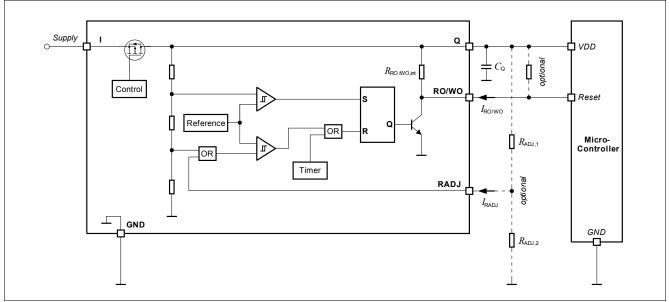


Figure 6 Block Diagram Reset Circuit

#### Reset Delay Time

The Reset Delay Time  $t_{rd}$  is fix defined according to **Table 7**.

#### Table 7Reset DelayTime

Reset delay timing	t <sub>rd</sub>
fix	16.5 ms

#### Power-On Reset Delay Time

The power-on reset delay time is defined by the parameter  $t_{rd}$  and allows a microcontroller and oscillator to start up. This delay time is the time period from exceeding the upper reset switching threshold  $V_{RT,high}$  until the reset is released by switching the reset output "RO/WO" from "LOW" to "HIGH".

#### Undervoltage Reset Delay Time

Unlike the power-on reset delay time, the undervoltage reset delay time is defined by the parameter  $t_{rd}$  and considers an output undervoltage event where the output voltage  $V_{Q}$  trigger the  $V_{RT,low}$  threshold.

#### Reset Blanking Time

The reset blanking time  $t_{rr,blank}$  avoids that short undervoltage spikes trigger an unwanted reset "low" signal.



#### **Reset Reaction Time**

In case the output voltage of the regulator drops below the output undervoltage lower reset threshold  $V_{\text{RT,low}}$ , the reset output "RO/WO" is set to low, after the delay of the internal reset reaction time  $t_{\text{rr,int}}$ . The reset blanking time  $t_{\text{rr,blank}}$  is part of the reset reaction time  $t_{\text{rr,int}}$ .

#### Reset Output "RO/WO"

The reset output "RO/WO" is an open collector output with an integrated pull-up resistor. In case a lower-ohmic "RO/WO" signal is desired, an external pull-up resistor can be connected to the output "Q". Since the maximum "RO/WO" sink current is limited, the minimum value of the optional external resistor " $R_{\text{RO/WO,ext}}$ " is given in **Table** "**Reset Output / Watchdog Output RO/WO**" on **Page 22**.

#### Reset Output "RO/WO" Low for VQ $\geq$ 1 V

In case of an undervoltage reset condition reset output "RO/WO" is held "low" for  $V_Q \ge 1$  V, even if the input voltage  $V_I$  is 0 V. This is achieved by supplying the reset circuit from the output capacitor.

#### **Reset Adjust Function**

The undervoltage reset switching threshold can be adjusted according to the application's needs by connecting an external voltage divider ( $R_{ADJ1}$ ,  $R_{ADJ2}$ ) at pin "RADJ". For selecting the default threshold connect pin "RADJ" to GND. The reset adjustment range for the TLS850F0TAV33 is given in **Reset Threshold Adjustment Range**.

When dimensioning the voltage divider, take into consideration that there will be an additional current constantly flowing through the resistors.

With a voltage divider connected, the reset switching threshold  $V_{\rm RT,new}$  is calculated as follows

(neglecting the Reset Adjust Pin Current  $I_{RADJ}$ ):

$$V_{\text{RT,lo,new}} = V_{\text{RADJ,th}} \times (R_{\text{ADJ,1}} + R_{\text{ADJ,2}}) / R_{\text{ADJ,2}}$$

with

- $V_{\text{RT,lo,new}}$ : Desired undervoltage reset switching threshold.
- $R_{ADJ,1}$ ,  $R_{ADJ,2}$ : Resistors of the external voltage divider, see Figure 6.
- $V_{\text{RADJ,th}}$ : Reset adjust switching threshold given in **Reset Adjustment Switching Threshold**.

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(1)



## TLS850F0TAV33

#### **Block Description and Electrical Characteristics**

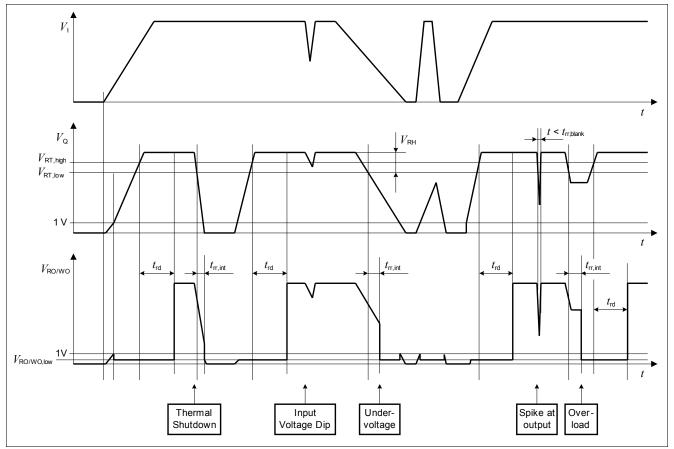


Figure 7 Typical Timing Diagram Reset



#### Table 8 Electrical Characteristics Reset

 $T_{\rm j}$  = -40 °C to +150 °C,  $V_{\rm l}$  = 13.5 V, all voltages with respect to ground (unless otherwise specified) Typical values are given at  $T_{\rm j}$  = 25 °C

Parameter	Symbol	Values			Unit	Note / Test Condition	Number	
		Min.	Тур.	Max.				
Output Undervoltage Reset 3V3 V	ersion only	y				1	1	
Output Undervoltage Reset Upper Switching Threshold	$V_{\rm RT,high}$	3.08	3.15	3.22	V	$V_{\rm Q}$ increasing	P_5.7.5	
Output Undervoltage Reset Lower Switching Threshold - Default	$V_{\rm RT,low}$	3.0	3.05	3.13	V	$V_{\rm Q}$ decreasing RADJ = GND	P_5.7.6	
Output Undervoltage Reset Switching Hysteresis	$V_{\rm RT,hy}$	60	100	-	mV	RADJ connected to GND	P_5.7.7	
Output Undervoltage Reset Headroom $V_{\rm Q}$ - $V_{\rm RT}$	V <sub>RH</sub>	100	250	-	mV	RADJ = GND	P_5.7.8	
Reset Threshold Adjustment						•		
Reset Adjustment Switching Threshold	$V_{RADJ,th}$	1.15	1.20	1.25	V	-	P_5.7.9	
Reset Threshold Adjustment Range	$V_{\rm RT,range}$	2.5	-	2.9	V	for $V_{\rm Q,nom}$ = 3.3 V	P_5.7.11	
Reset Output / Watchdog Output		4						
Reset Output Watchdog Output Low Voltage	$V_{\rm RO/WO,low}$	-	0.2	0.4	V	$1 V \le V_Q \le V_{RT};$ $R_{RO/WO} \ge 5.1 \text{ k}\Omega$	P_5.7.16	
Reset Output Watchdog Output Internal Pull-Up Resistor	R <sub>RO/WO,int</sub>	13	20	36	kΩ	internally connected to Q	P_5.7.17	
Reset Output Watchdog Output External Pull-up Resistor to $V_{\rm Q}$	R <sub>RO/WO,ext</sub>	5.1	-	-	kΩ	$1 \text{ V} \leq V_{\text{Q}} \leq V_{\text{RT}};$ $V_{\text{RO/WO}} \leq 0.4 \text{ V}$	P_5.7.18	
Reset Delay Timing								
Reset Delay Time	t <sub>rd</sub>	13.2	16.5	19.8	ms	Fixed Timing	P_5.7.39	
Reset blanking time	t <sub>rr,blank</sub>	-	6	-	μs	<sup>1)</sup> for $V_{Q,nom}$ = 3.3 V	P_5.7.22	
Internal Reset Reaction Time	t <sub>rr,int</sub>	-	7	20	μs	for $V_{\rm Q,nom}$ = 3.3 V	P_5.7.23	

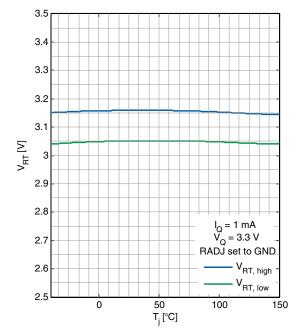
1) Not subject to production test, specified by design.



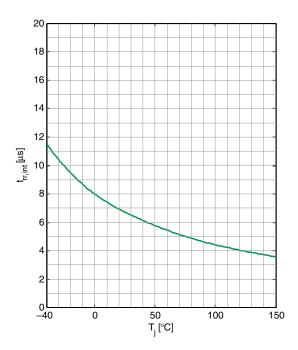
## 5.8 Typical Performance Characteristics Reset

#### **Typical Performance Characteristics**

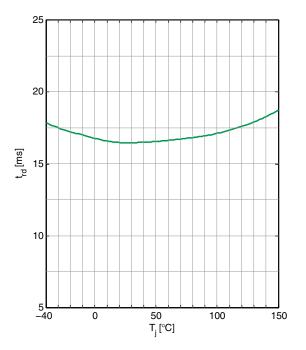
# Undervoltage Reset Threshold $V_{\rm RT}$ versus Junction Temperature $T_{\rm j}$



Internal Reset Reaction Time  $t_{\rm rr,int}$  versus Junction Temperature  $T_{\rm j}$ 



Power On Reset Delay Time  $t_{rd}$  versus Junction Temperature  $T_i$ 



Data Sheet



## 5.9 Standard Watchdog

The TLS850F0TAV33 features a load dependent watchdog function. The watchdog function monitors a microcontroller, including time base failures. In case of a missing falling edge within a certain pulse repetition time, the watchdog output "RO/WO" is set to "low".

The watchdog uses an internal oscillator as timebase. The effective trigger window is derived from the watchdog timebase.

The watchdog output signal is provided by a combined Reset Output / Watchdog Output "RO/WO" pin.

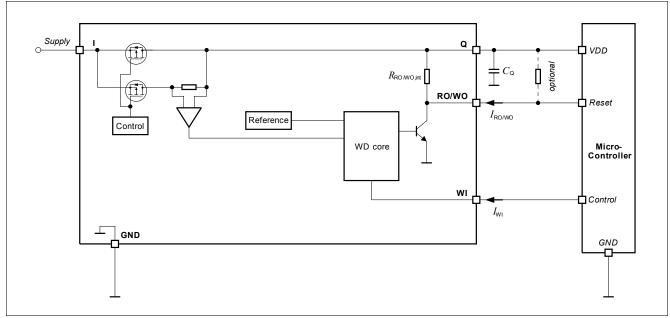


Figure 8 Block Diagram Watchdog Circuit

#### Watchdog Timing

**Figure 9** shows the state diagram of the watchdog (WD) and the mode selection. After power-on, the reset output signal at the "RO/WO" pin (microcontroller reset) is kept LOW for the reset delay time  $t_{rd}$ . With the LOW to HIGH transition of the signal at "RO/WO" the device starts the watchdog ignore time  $t_{WLi}$ . Next, the WD starts the watchdog trigger time (time frame within a trigger at WI must occur).

From now on, the timing of the signal on WI from the microcontroller must fit to the WD-trigger time  $t_{WI,tr}$ . A Re-Trigger of the WD-trigger time is done with a HIGH-to-LOW transient at the WI-pin within the active  $t_{WI,tr}$ .

#### Watchdog Output "RO/WO"

The watchdog output "RO/WO" is an open collector output with an integrated pull-up resistor. In case a lowerohmic "RO/WO" signal is desired, an external pull-up resistor can be connected to the output "Q". Since the maximum "RO/WO" sink current is limited, the minimum value of the optional external resistor " $R_{\text{RO/WO,ext}}$ " is given in **Table "Reset Output / Watchdog Output RO/WO" on Page 22**. A HIGH to LOW transition of the watchdog trigger signal on pin WI is taken as a trigger. A watchdog signal is generated ("RO/WO" goes LOW), if there is no trigger pulse during the Watchdog trigger time.



## TLS850F0TAV33

#### **Block Description and Electrical Characteristics**

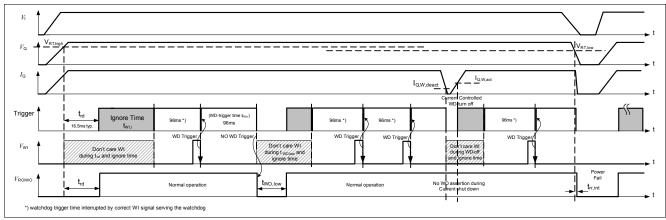


Figure 9 Typical Watchdog Timing Diagram, Watchdog and Reset Modes

#### Watchdog Input "WI"

The watchdog is triggered by a falling edge at the watchdog input pin "WI". The amplitude and slope of this signal has to comply with the specification (Table "Watchdog Input WI" on Page 26). For details regarding test pulses, see Figure 10 "Test Pulses Watchdog Input WI" on Page 25.

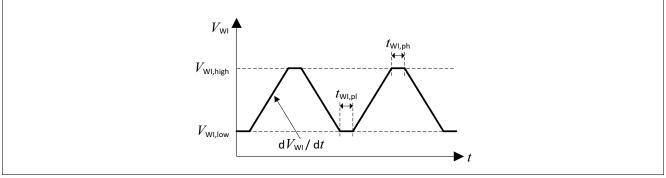


Figure 10 Test Pulses Watchdog Input WI



#### Table 9 Electrical Characteristics Watchdog

 $T_j$  = -40 °C to +150 °C,  $V_l$  = 13.5 V, all voltages with respect to ground (unless otherwise specified) Typical values are given at  $T_i$  = 25 °C

Parameter	Symbol		Value	S	Unit	Note / Test Condition	Number
		Min.	Тур.	Max.			
Watchdog Timing							
Watchdog Ignore Time	t <sub>WI,i</sub>	12.8	16	19.2	ms	-	P_5.9.1
Watchdog Trigger Time	t <sub>WI,tr</sub>	76.8	96	115.2	ms	-	P_5.9.2
Watchdog Output Low Time	t <sub>WO,low</sub>	6.4	8	9.6	ms	-	P_5.9.6
Load Dependent Watchdog Acti	vation						
Watchdog Activation Current Threshold	$I_{\rm Q,W,act}$	-	-	5.5	mA	for $V_{Q,nom}$ = 3.3 V: $V_1$ > 4.23 V; high current condition must	P_5.9.45
						be applied at least for the time of $t_{W,filter,max}$	
Watchdog Deactivation Current Threshold	I <sub>Q,W,deact</sub>	1	_	-	mA	for $V_{Q,nom} = 3.3 V$ : $V_1 > 4.23 V$ ; low current condition must be applied at least for the time of t	P_5.9.46
Watchdog Deactivation Current Hysteresis	$I_{\rm Q,W,hy}$	0.35	-	-	mA	time of $t_{W,\text{filter,max}}$ for $V_{Q,\text{nom}} = 3.3 \text{ V}$ : $V_1 > 4.23 \text{ V}$ ;	P_5.9.47
Watchdog Minimum Filter Time state transition by current	t <sub>W,IQ,filter,</sub>	100	-	-	μs	<sup>1)</sup> – see <b>Page 27</b>	P_5.9.14
Watchdog Maximum Filter Time state transition by current	t <sub>W,IQ,filter,</sub> max	-	-	500	μs	<sup>1)</sup> – see <b>Page 27</b>	P_5.9.15
Watchdog Input WI		·					
Watchdog Input Low Signal Valid	$V_{\rm WI,low}$	-	-	0.8	V	2) _	P_5.9.16
Watchdog Input High Signal Valid	$V_{\rm WI,high}$	2.0	-	-	V	2) _	P_5.9.17
Watchdog Input High Signal Pulse Length	t <sub>WI,ph</sub>	1	-	-	μs	<sup>2)</sup> $V_{WI} \ge V_{WI,high}$	P_5.9.19
Watchdog Input Low Signal Pulse Length	t <sub>WI,pI</sub>	1	-	-	μs	<sup>2)</sup> $V_{WI} \leq V_{WI,low}$	P_5.9.20
Watchdog Input Signal Slew Rate	dV <sub>WI</sub> /d <i>t</i>	1	-	-	V/µs	$^{2)} V_{\rm WI,low} < V_{\rm WI} < V_{\rm WI,high}$	P_5.9.21
High Level Input Current	$I_{\rm WI,H}$	-	-	3.5	μA	V <sub>WI</sub> = 3.3 V	P_5.9.22
Watchdog Input internal pull-down resistor	R <sub>WI</sub>	0.9	1.5	2.6	MΩ	-	P_5.9.23
Watchdog Disable Threshold WI Signal Value	$V_{\rm WI,dis}$	1.15	-	1.40	V	for $V_{Q,nom}$ = 3.3 V: $V_1$ > 4.6 V; signal must be applied for > $t_{W,filter,max}$ to deactivate and activate the watchdog	P_5.9.24



#### Table 9 Electrical Characteristics Watchdog (cont'd)

 $T_j$  = -40 °C to +150 °C,  $V_l$  = 13.5 V, all voltages with respect to ground (unless otherwise specified) Typical values are given at  $T_i$  = 25 °C

Parameter	Symbol	Values			Unit	Note / Test Condition	Number
		Min.	Тур.	Max.			
Watchdog Minimum Filter Time state transition by WI	<i>t</i> <sub>WI,filter,min</sub>	100	-	-	μs	<sup>3)</sup> – see <b>Page 28</b>	P_5.9.25
Watchdog Maximum Filter Time state transition by WI	t <sub>WI,filter,max</sub>	_	-	500	μs	<sup>3)</sup> – see <b>Page 28</b>	P_5.9.26
Reset Output / Watchdog Outpu	ut RO/WO is	s defin	ed in o	chapte	r Rese	t Output / Watchdog Out	put RO/WO

1) Not subject to production test, specified by design.

2) For details on applied test pulse, see Figure 10

3) Not subject to production test, specified by design.

#### Watchdog Trigger Time

The Watchdog Trigger Time  $t_{WI,tr}$  is fixed to a static value according to **Table 10**.

#### Table 10Watchdog Trigger Time

Watchdog trigger timing	<i>t</i> <sub>WI,tr,typ</sub>
fix to	96 ms

#### Watchdog deactivation by current control

The Watchdog is load dependent inactive. This ensures, that if the microcontroller is in a power save mode  $(I_Q \leq I_{Q,W,deact})$  and not able to provide a correct watchdog trigger signal at pin "WI", no watchdog signal "RO/WO = low" is generated. The transition from an active to an inactive state will be performed after a dead time of  $t_{W,IQ,filter,max}$ , when output current keeps below the deactivation threshold. This protects against an unintended entering of the watchdog deactivation state caused by short dynamic current drops. In case of very short current drops up to the time of  $t_{W,IQ,filter,min}$ , the activation state will definitely be kept. These scenarios are also valid for the transition from deactivation to activation state. For details see also

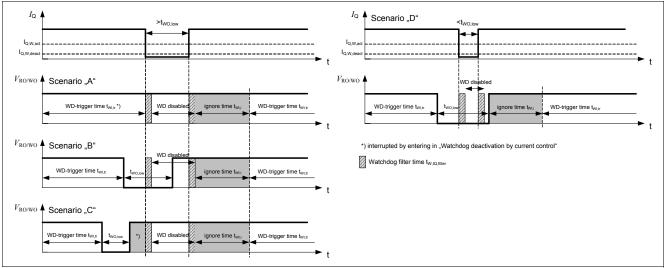


Figure 11 Watchdog Output behavior for Watchdog deactivation by current control



#### Scenario "A"

In scenario "A" the watchdog logic expects a next trigger at WI pin within the WD-trigger time  $t_{WI,tr}$ . This state is interrupted by the low current load state ( $I_Q \leq I_{Q,W,deact}$ ). During this state, the watchdog is disabled. The watchdog output signal "RO/WO" will stay high while the watchdog is disabled. After leaving the low current load state ( $I_Q \geq I_{Q,W,act}$ ), an ignore window  $t_{WI,i}$  follows. After this, the watchdog trigger time  $t_{WI,tr}$  starts. This behavior is defined for cases with a low current load time greater than  $t_{WO,low}$ .

#### Scenario "B"

In scenario "B" the watchdog is not served within WD-trigger time  $t_{WI,tr}$  with an trigger event at WI pin. As a result the "RO/WO" is set to low. This state is interrupted by the low current load state ( $I_Q \le I_{Q,W,deact}$ ). During this state, the watchdog is disabled. The watchdog output signal "RO/WO" is kept in low state for  $t_{WO,low}$  and then the "RO/WO" is set to high. After leaving the low current load state ( $I_Q \ge I_{Q,W,act}$ ), an ignore window  $t_{WI,i}$  follows. After this, the watchdog trigger time  $t_{WI,tr}$  starts. This behavior is defined for cases with a low current load time greater than  $t_{WO,low}$ .

#### Scenario "C"

In scenario "C" the watchdog is not served within WD-trigger time  $t_{WI,tr}$  with an trigger event at WI pin. As a result the "RO/WO" is set to low. After this an ignore window follows. This state is interrupted by the low current load state ( $I_Q \leq I_{Q,W,deact}$ ). During this state, the watchdog is disabled. The watchdog output signal "RO/WO" will stay high while the watchdog is disabled. After leaving the low current load state ( $I_Q \geq I_{Q,W,act}$ ), an ignore window  $t_{WI,i}$  follows. After this, the watchdog trigger time  $t_{WI,tr}$  starts. This behavior is defined for cases with a low current load time greater than  $t_{WO,low}$ .

#### Scenario "D"

In scenario "D" the watchdog is not served within WD-trigger time  $t_{WI,tr}$  with a trigger event at WI pin. As a result the "RO/WO" is set to low. This state is interrupted by the low current load state ( $I_Q \le I_{Q,W,deact}$ ). During this state, the watchdog is disabled. The watchdog output signal "RO/WO" is kept in low state for the time of low current load state. After leaving the low current load state ( $I_Q \ge I_{Q,W,act}$ ), an ignore window  $t_{WI,i}$  follows. After this, the watchdog trigger time  $t_{WI,tr}$  starts. This behavior is defined for cases with a low current load time less than  $t_{WO,low}$ .

#### Watchdog deactivation by external signal (pin "WI")

Note: Disabling the watchdog should only considered when the application is not running in the normal operating conditions as the safe operation is not ensured any more. Example would be the flashing process of the microcontroller.

The Watchdog can be disabled by connecting a voltage level between the range of 1.15 V to 1.40 V to WI. By entering the Watchdog deactivation, the "RO/WO" signal behaves like it is described in . The transition from active to an inactive state will be performed after a dead time of  $t_{WI,filter,max}$ , when correct level to WI pin is applied. This protects against the unintended entering of watchdog deactivation state. After leaving the deactivation voltage range 1.15 V to 1.40 V, the Watchdog is again active and starts with an ignore window. This scenario is also valid for the transition from deactivation to activation state.



## TLS850F0TAV33

#### **Block Description and Electrical Characteristics**

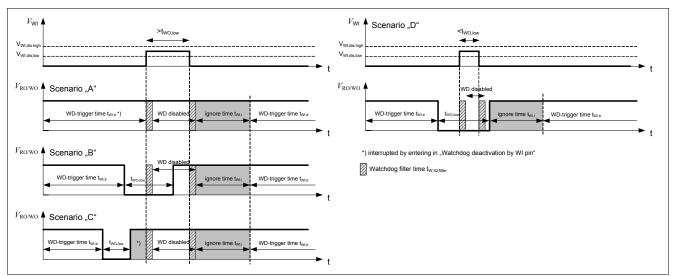


Figure 12 Watchdog Output behavior for Watchdog deactivation by WI pin

#### Scenario "A"

In scenario "A" the watchdog logic expects a next trigger at WI pin within the WD-trigger time  $t_{WI,tr}$ . This state is interrupted by setting  $V_{WI}$  to the disable condition ( $V_{WI,dis,low} \le V_{WI} \le V_{WI,dis,high}$ ). During this state, the watchdog is disabled. The watchdog output signal "RO/WO" will stay high while the watchdog is disabled. After leaving the disable condition ( $V_{WI} \ge V_{WI,dis,high}$  or  $V_{WI} \le V_{WI,dis,low}$ ), an ignore window  $t_{WI,i}$  follows. After this, the watchdog trigger time  $t_{WI,tr}$  starts. This behavior is defined for cases with a low current load time greater than  $t_{WO,low}$ .

#### Scenario "B"

In scenario "B" the watchdog is not served within WD-trigger time  $t_{WI,tr}$  with an trigger event at WI pin. As a result the "RO/WO" is set to low. This state is interrupted by setting  $V_{WI}$  to the disable condition  $(V_{WI,dis,low} \le V_{WI} \le V_{WI,dis,high})$ . During this state, the watchdog is disabled. The watchdog output signal "RO/WO" is kept in low state for  $t_{WO,low}$  and then the "RO/WO" is set to high. After leaving the disable condition  $(V_{WI} \ge V_{WI,dis,high})$ , an ignore window  $t_{WI,i}$  follows. After this, the watchdog trigger time  $t_{WI,tr}$  starts. This behavior is defined for cases with a low current load time greater than  $t_{WO,low}$ .

#### Scenario "C"

In scenario "C" the watchdog is not served within WD-trigger time  $t_{WI,tr}$  with an trigger event at WI pin. As a result the "RO/WO" is set to low. After this an ignore window follows. This state is interrupted by setting  $V_{WI}$  to the disable condition ( $V_{WI,dis,low} \le V_{WI} \le V_{WI,dis,high}$ ). During this state, the watchdog is disabled. The watchdog output signal "RO/WO" will stay high while the watchdog is disabled. After leaving the disable condition ( $V_{WI,dis,high} \le V_{WI,dis,high}$ ), an ignore window  $t_{WI,i}$  follows. After this, the watchdog trigger time  $t_{WI,tr}$  starts. This behavior is defined for cases with a low current load time greater than  $t_{WO,low}$ .

#### Scenario "D"

In scenario "D" the watchdog is not served within WD-trigger time  $t_{WI,tr}$  with a trigger event at WI pin. As a result the "RO/WO" is set to low. This state is interrupted by setting  $V_{WI}$  to the disable condition  $(V_{WI,dis,low} \le V_{WI} \le V_{WI,dis,high})$ . During this state, the watchdog is disabled. The watchdog output signal "RO/WO" is kept in low state for the time of low current load state. After leaving the disable condition  $(V_{WI} \ge V_{WI,dis,high})$ , an ignore window  $t_{WI,i}$  follows. After this, the watchdog trigger time  $t_{WI,tr}$  starts. This behavior is defined for cases with a low current load time less than  $t_{WO,low}$ .

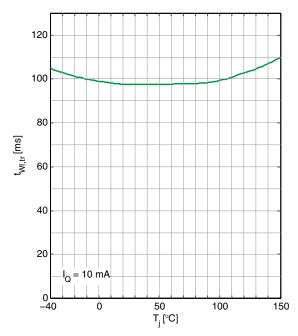
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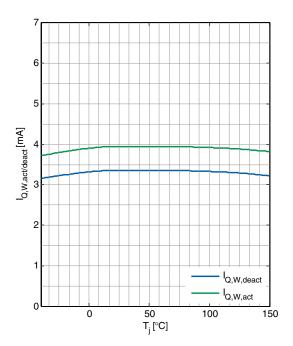
## 5.10 Typical Performance Characteristics Standard Watchdog

#### **Typical Performance Characteristics**

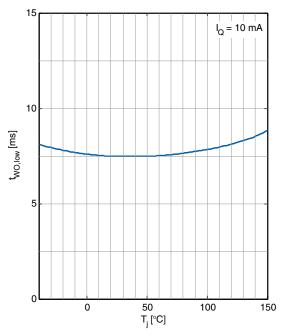
Watchdog Trigger Time  $t_{WI,tr}$  versus Junction Temperature  $T_j$ 



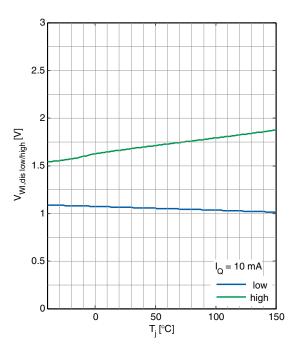
Watchdog Activation/Deactivation Current  $I_{Q,W,act}$ ,  $I_{Q,W,deact}$  versus Junction Temperature  $T_j$ 



Watchdog Output Low Time  $t_{WO,low}$  versus Junction Temperature  $T_i$ 



Watchdog Disable  $V_{\rm Wl,dis}$  Threshold versus Junction Temperature  $T_{\rm j}$ 



Data Sheet

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**Application Information** 

## 6 Application Information

## 6.1 Application Diagram

Note: The following information is given as a hint for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

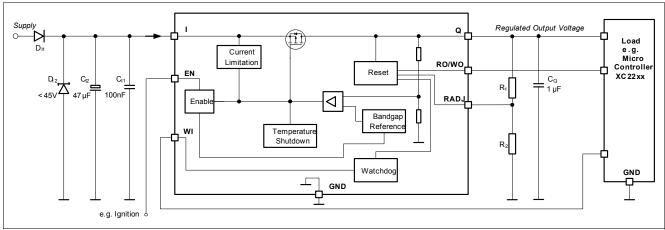


Figure 13 Application Diagram

Note: This is a very simplified example of an application circuit. The function must be verified in the real application.

## 6.2 Selection of External Components

## 6.2.1 Input Pin

The typical input circuitry for a linear voltage regulator is shown in the application diagram above.

A ceramic capacitor at the input, in the range of 100 nF to 470 nF, is recommended to filter out the high frequency disturbances imposed by the line e.g. ISO pulses 3a/b. This capacitor must be placed very close to the input pin of the linear voltage regulator on the PCB.

An aluminum electrolytic capacitor in the range of 10  $\mu$ F to 470  $\mu$ F is recommended as an input buffer to smooth out high energy pulses, such as ISO pulse 2a. This capacitor should be placed close to the input pin of the linear voltage regulator on the PCB.

An overvoltage suppressor diode can be used to further suppress any high voltage beyond the maximum rating of the linear voltage regulator and protect the device against any damage due to over-voltage.

The external components at the input are not mandatory for the operation of the voltage regulator, but they are recommended in case of possible external disturbances.

## 6.2.2 Output Pin

An output capacitor is mandatory for the stability of linear voltage regulators.

The requirement to the output capacitor is given in "Functional Range" on Page 8. The graph "Output Capacitor Series Resistor ESR(CQ) versus Output Current IQ" on Page 13 shows the stable operation range of the device.

Data Sheet

## TLS850F0TAV33



#### **Application Information**

(2)

(3)

TLS850F0TAV33 is designed to be also stable with low ESR capacitors. According to the automotive requirements, ceramic capacitors with X5R or X7R dielectrics are recommended.

The output capacitor should be placed as close as possible to the regulator's output and GND pins and on the same side of the PCB as the regulator itself.

In case of rapid transients of input voltage or load current, the capacitance should be dimensioned in accordance and verified in the real application that the output stability requirements are fulfilled.

### 6.3 Thermal Considerations

Knowing the input voltage, the output voltage and the load profile of the application, the total power dissipation can be calculated:

$$P_{\mathsf{D}} = (V_{\mathsf{I}} - V_{\mathsf{Q}}) \times I_{\mathsf{Q}} + V_{\mathsf{I}} \times I_{\mathsf{q}}$$

with

- *P*<sub>D</sub>: continuous power dissipation
- $V_{\rm I}$ : input voltage
- V<sub>Q</sub>: output voltage
- I<sub>Q</sub>: output current
- *I*<sub>a</sub>: quiescent current

The maximum acceptable thermal resistance  $R_{thJA}$  can then be calculated:

$$R_{\text{thJA,max}} = (T_{\text{j,max}} - T_{\text{a}}) / P_{\text{D}}$$

with

- *T*<sub>i.max</sub>: maximum allowed junction temperature
- *T*<sub>a</sub>: ambient temperature

Based on the above calculation the proper PCB type and the necessary heat sink area can be determined with reference to the specification in "Thermal Resistance" on Page 9.

#### Example

Application conditions:

 $V_{I} = 13.5 V$  $V_{Q} = 3.3 V$  $I_{Q} = 175 mA$  $T_{a} = 85 °C$ 

Calculation of  $R_{thJA,max}$ :  $P_{D} = (V_{I} - V_{Q}) \times I_{Q} + V_{I} \times I_{q}$  ( $V_{I} \times I_{q}$  can be neglected because of very low  $I_{q}$ ) = (13.5 V - 3.3 V) × 175 mA = 1.785 W  $R_{thJA,max} = (T_{j,max} - T_{a}) / P_{D}$ = (150 °C - 85 °C) / 1.785 W = 36.41 K/W



#### **Application Information**

As a result, the PCB design must ensure a thermal resistance  $R_{thJA}$  lower than 36.41 K/W. According to "**Thermal Resistance**" on **Page 9**, at least 600 mm<sup>2</sup> heatsink area is needed on the FR4 1s0p PCB, or the FR4 2s2p board can be used to ensure a proper cooling for the TLS850F0TAV33 in package.

## 6.4 Reverse Polarity Protection

TLS850F0TAV33 is not self protected against reverse polarity faults and must be protected by external components against negative supply voltage. An external reverse polarity diode is needed. The absolute maximum ratings of the device as specified in "Absolute Maximum Ratings" on Page 7 must be kept.

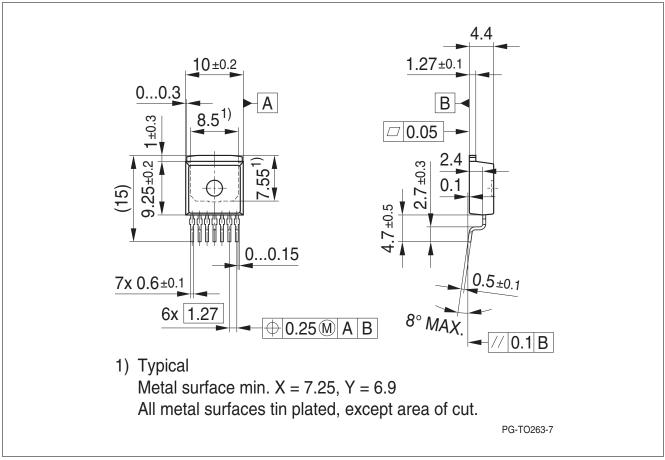
## 6.5 Further Application Information

• For further information you may contact http://www.infineon.com/



**Package Outlines** 

## 7 Package Outlines



### Figure 14 PG-TO263-7

#### Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

For further information on alternative packages, please visit our website: http://www.infineon.com/packages.

Dimensions in mm



#### **Revision History**

## 8 Revision History

Revision	Date	Changes
1.0	2015-12-01	Data Sheet - Initial version

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